

Micro-Electronics Assembler

The position requires steady hands for handling miniature materials which may only be visible with microscopes.

The employee will receive on the job training as needed, the individual will have daily assembly responsibilities with general supervision.

Duties will include:

- Primary responsibility is the operation of electronic epoxy die placement equipment

Additional tasks may include:

- Die Bonding
- Operation of gold wire bonding equipment
- Laser trimming of thick film resistors on thick film substrates
- Testing of microelectronic assemblies to customer specifications

Requires minimal job knowledge/skills. Requires a High School diploma of equivalent, previous micro-electronic, electronic assembly or cleanroom assembly experience is a plus. US citizenship or permanent residency is required.

This is a full-time position. Choice of hours:

**2:30 pm – 1:00 am Monday – Thursday or
6:00 am – 3:00 pm Monday – Thursday and 6:00 am – Noon on Friday**